



Features:

- Industry standard 1/4brick package & footprint
- (2.28"×1.45"×0.44")
- High power density: 47.8 W/in³
- High efficiency
- 2:1 Input voltage range
- Low output noise & ripple
- Remote sense
- Constant frequency
- Over-temperature protection: Auto-recovery
- Output over-voltage: shutdown, locked
- Dual Output (Adjustable Voltage): +25%/-25%
- Output over-current protection
- Wide baseplate operating temperature range -40 to -100°C
- EN60950-1 Certified
- RoHS (2002/95/EC) complaint

Industry Standard 1/4 brick:
48Vin 3.3Vout 12A; 1.2Vout 25A

Options:

- Positive/Negative and Remote on/off
- Sprayed Conformal coating

Numbering Convention

QSR 40-48 D 3V3 1V2 -L B -C G5
 1 2 3 4 5 6 7 8 9 10

NO	Features	Descriptions
1	Product Series	Open-frame 1/4 brick series
2	Output Current	3.3V/12A; 1.2V/25A
3	Typical Input Voltage	Typical Input Voltage: 48V
4	Number of Outputs	D - Double Output
5	Output I	3V3 - Typical Output Voltage: 3.3V
6	Output II	1V2 - Typical Output Voltage: 1.2V
7	Remote on/off Logic	L - Negative Logic
		H or Default - Positive Logic
8	Aluminum Heat Sink	B – Heat Sink
		Default - No Heat Sink
9	Sprayed conformal coating	C - Sprayed Conformal coating
		Default - No Sprayed Conformal coating
10	ROHS	G - lead-free, ROHS6
		G5-ROHS5
		Default - lead

1 Description

The QSR40-48D3V31V2 series power modules are open-frame DC-DC converters in an industry 1/4 brick packaging & footprint equipped with an option of baseplate (heat sink). The converters can provide two outputs: 3.3V/12A and 1.2V/25A. The converters feature wide input voltage range, high efficiency, excellent thermal performance, high isolation voltage, and are well suited for telecommunication, industrial automation and test equipments, etc.

2 Technical Specifications (Unless otherwise stated, all specifications are typical at nominal input, full load, 25°C. and a wind speed of 1m/S. Externally add two capacitors to the test tooling, one 100 μ F/100V electrolytic capacitor for the input, and one 220 μ F/10V tantalum capacitor for the output)

Parameter	Test Condition	Min	Typ	Max	Unit
2.1 Absolute Maximum Ratings					
Input Voltage (Vi)	Non-operating, continuous	0	—	80	Vdc
	transient (100ms)	—	—	100	Vdc
Max Output Power (Pomax)	allowable operating conditions	—	—	70	W
2.2 Input Specifications					
Typical Input Voltage (Vinom)	—	—	48	—	Vdc
Input Voltage Range	—	36	—	75	Vdc
Input Under-voltage Protection	lonom	30	—	34	Vdc
Input Under-voltage Recovery Point	lonom	32	—	36	Vdc
Maximum Input Current (Iimax)	Vimin, Vonom, lonom	—	—	2.35	A
No-load Input Current (Iio)	Vinom, Io=0A	—	90	100	mA
Quiescent Input Current (Iiof)	Vinom, remote output shutdown	—	—	20	mA
No-load Power Loss	Vinom, Io=0A	—	4.32	4.8	W
Inrush Transient current	Io=lonom	—	—	1	A ² S
Input Reflected Ripple Current (peak-to-peak)	5Hz~20MHz, 12 μ H Absorption Inductor, 0.1 μ F ceramic capacitor, 100 μ F electrolytic capacitor	—	—	50	mA
Remote	On	Rem:connected to -Vin or below 1.8V (reference to -Vin); Current: 0.5~2mA			
	Off	Rem: open circuit or 3.5V~12V(reference to -Vin);			
2.3 Output Specifications					
Output voltage Set-point (Vonom)	Vinom, lonom, Vo1	3.3	3.33	3.38	Vdc
	Vinom, lonom, Vo2	1.2	1.22	1.24	Vdc
Output Current (lonom)	Io1	—	12	—	A
	Io2	—	25	—	A
Output Current Range (Io)	Po \leq 70W, Io1	0	—	12	A
	Po \leq 70W, Io2	0	—	25	A

Parameter		Test Condition	Min	Typ	Max	Unit
Line Regulation (Vov)		V _{imin} -V _{imax} , I _{on} , V _{o1}	—	±0.5	±1	%V _{o1}
		V _{imin} -V _{imax} , I _{on} , V _{o2}	—	—	±10	mV
Load Regulation (Vol)		0-100%I _{on} , V _{in} , V _{o1}	—	±0.5	±1	%V _{o1}
		0-100%I _{on} , V _{in} , V _{o2}	—	—	±20	mV
Cross Regulation		V _{o1} , Full voltage, Full Load, Room Temperature	—	—	1.5	%V _{o1}
		V _{o2} , Full voltage, Full Load, Room Temperature	—	—	20	mV
Output Voltage Trim Range (Voadj)		I _{o1} ≤12A, I _{o2} ≤25A (Output II: adjustable; Output I: not adjustable)	-25	—	+25	%V _{o2}
Output Over-voltage Protection	Protection Mode	—	No-load or light load, lockout, power on to recovery			—
	Threshold	P _o <P _{omax} , V _{o1}	4		5	V _{dc}
P _o <P _{omax} , V _{o2} (0.9V~1.5V)		120		150	%V _{o2}	
Output Over-current Protection	Protection Mode	—	Hiccup, Auto-recovery			—
	Threshold	V _{o1} : over-current(V _{o2} : full load)	16		23	A
V _{o2} : over-current(V _{o1} : full load)		28		50	A	
Output Short-circuit Protection	Protection Mode	—	Hiccup, Auto-recovery			—
Dynamic Load Response	Peak Deviation	25%-50%-25%I _{on} , 50%-75%-50%I _{on} , ΔI _o /Δt=0.1A/μS, V _{in} , C _{o1} =220μF	—	—	5%	V _{o1/2}
	Settling Time		—	—	200	μs
	Peak Deviation	0%-100%-0%I _{on} , ΔI _o /Δt=0.1A/μS, V _{in} , C _{o2} =220μF	—	—	50%	V _{o1/2}
	Settling Time		—	—	800	μs
Output Ripple & Noise (Peak-to-Peak)	①	V _{o1} p-p (20MHz)	—	—	60	mV
		V _{o2} p-p (20MHz)	—	—	50	mV
	①	V _{o1} p-p (100MHz)	—	—	200	mV
		V _{o2} p-p (100MHz)	—	—	200	mV
External Output Capacitance (C _o)		V _{in} MIN~V _{in} MAX, 0~100%I _o , V _{o1}	220	—	5000	μF
		V _{in} MIN~V _{in} MAX, 0~100%I _o , V _{o2}	220	—	10000	μF
Turn-on/off Peak Deviation		V _{in} , I _{on} , V _{o1}	—	—	±5	%V _{o1}
		V _{in} , I _{on} , V _{o2}	—	—	50	mV
Turn-on Delay Time		90%V _{in} --- 10%V _{on}	0	5	30	mS
Turn-on Rise Time		10%V _{on} ---90%V _{on}	0	5	20	mS
Remote Voltage Sampling		—	Available			
2.4 Safety Specifications						

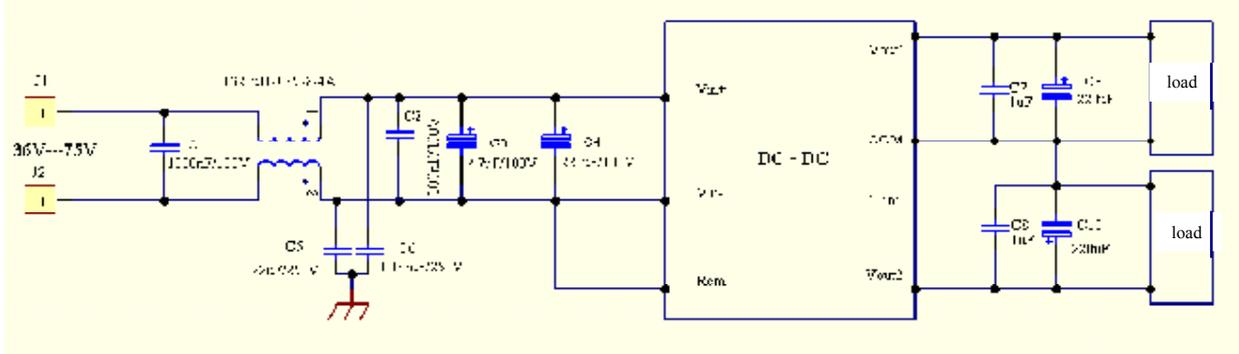
Parameter		Test Condition	Min	Typ	Max	Unit
Isolation Voltage	Input to output	Leak Currents ≤ 1mA, 1min	1500	—	—	Vdc
Isolation Resistance (R _{ISO})		500V _{DC}	50	—	—	MΩ
Safety Certificate		EN60950-1 Recognized				
2.5 Reliability						
Vibration Test(sine)		ΔI _o /Δt=: 10~55Hz Amplitude: 0.35mm Acceleration: 10m/s ² Cycle: X,Y,Z 30min each axis	After being tested, no damage to the converter and its components, the appearance, output voltage and output ripple and noise (p-to-p) meet the data sheet requirements.			
Impact Test (half-sine)		Peak Acceleration: 300m/s ² Duration: 6ms 6 times for three perpendicular directions	After being tested, no damage to the converter and its components, the appearance, output voltage and output ripple and noise (p-to-p) meet the data sheet requirements.			
MTBF		≥ 2 × 10 ⁶ h Bellcore TR-332 (Ta=25°C)				
		≥ 1 × 10 ⁶ h Bellcore TR-332 (Ta=50°C)				
2.6 Environmental Specifications						
Relative Humidity		(40±2) °C, No dew	—	—	95	%RH
Cooling		—	Conduction Cooling (Forced-air cooling or heat sink)			
Over-temperature protection		—	85°C~100°C (Thermistor Temperature, Auto-recovery)			
Operating Ambient Temperature		See the derating curve	-40	—	+85	°C
Storage Temperature (T _{st})			-40	—	+125	°C
2.7 General Specifications						
Switching Frequency		—	—	300	—	k Hz
Temperature Coefficient (Tcoeff)		-40°C~+85°C	—	—	±0.02	%/°C
Efficiency (η)		V _{in} om,100% (I _{O1} +I _{O2})	85.5	86	—	%
		V _{in} om,20% (I _{O1} +I _{O2})		78		%
		V _{in} om,50% (I _{O1} +I _{O2})		86		%
		V _{in} om,80% (I _{O1} +I _{O2})		86.5		%
Weight		—		35		g
RoHS		2002/95/EC Directive				
Anti-sulfuration feature		With a suffix "C" in model number	Sprayed conformal coating			

Note:

① 20MHz, besides the 220μF capacitors (one for each output) on the test tooling, add a 10μF/10V tantalum capacitor to the ripple test tooling for Vo1, and a 1μF ceramic capacitor for Vo2, at ambient temperature -25°C to +55°C; for other ambient temperature, 3.3V: 100mV Ripple & Noise, 1.2V: 100mV Ripple & Noise.

3 Basic Application Circuit and Considerations

3.1 Typical Application (Negative Remote on/off)



Fuse: 5.0A; C1: 100V, $\geq 100\mu\text{F}$; C2: $1\mu\text{F}/10\text{V}$ (Monolithic Capacitor); C3: $220\mu\text{F}/6.3\text{V}$ (Tantalum Capacitor); C4: $1\mu\text{F}/10\text{V}$ (Monolithic Capacitor); C5: $220\mu\text{F}/6.3\text{V}$ (Tantalum Capacitor);

3.2 Input Voltage up to 80Vdc for long time or reverse input polarity would cause the module damaged.

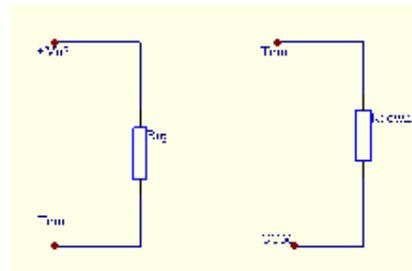
3.3 Output will be off when the Rem is at high level or when the Rem keeps open circuit referenced to $-V_{in}$;

Output will be on when the Rem is at low level or shorted to $-V_{in}$.

3.4 Output short-circuit protection model is hiccup, automatic recovery.

3.5 Output Trim: V_{o1} (3.3V) is not adjustable, but V_{o2} (1.2V) is adjustable. Exceed the maximum output power (trim up) of V_{o2} or the maximum output current (trim down) of V_{o2} may cause the converter operate abnormally. The output voltage shall not exceed 1.5V (trim up) or below 0.9V (trim down), or the module may operate abnormally. See "3.6 Output Voltage Adjustment (Trim)" for details.

3.6 Output Voltage Adjustment (Trim)



Trim-up

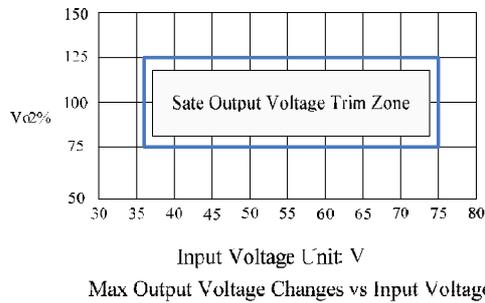
Trim-down

$$\text{Trim-down: } R_{down} = \frac{2.82V_{o2}}{V_{o2nom} - V_{o2}} - 2.4$$

$$\text{Trim-up: } R_{up} = \frac{(4.75V_{o2nom} - 2.82)V_{o2}}{V_{o2} - V_{o2nom}} - 2.4$$

Where V_{o2nom} is the nominal output voltage of V_{o2} , V_{o2} is the adjusted output voltage of V_{o2} , and R_{down} and R_{up} are external adjusting resistors. Units: $k\Omega$.

Note: V_{o1} is not adjustable, but V_{o2} is adjustable. The over-voltage protection functions if the out voltage is trimmed up higher than the threshold.



Ripple & noise: add a 10 μ F Tantalum capacitor and a 1 μ F ceramic capacitor to the test tooling of Vo1 and Vo2.

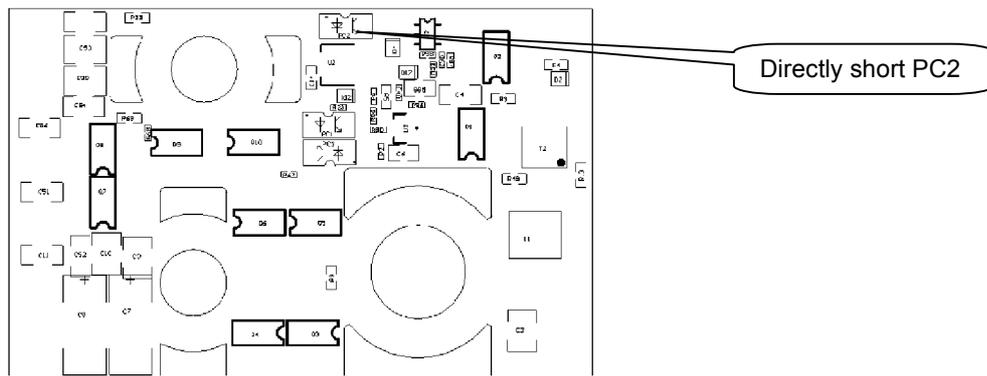
3.7 Over-current Protection

Operating at over-current conditions for long time may cause damage to the module; if the output is in short-circuits, the module is in hiccup mode, and the output current varies from a few mA to hundreds of mA.

3.8 Over-voltage Protection

The over-voltage protection of Output I and Output II will deadlock when there is no load or light load, and recover after re-power-on.

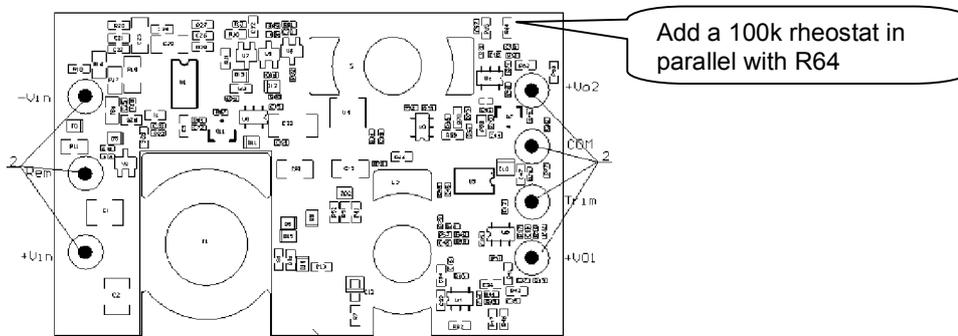
Test Methods for Output I: directly short PC2 (diode).



Non-pin Side

There is a bit of troubles for Output II, because the over-voltage protection threshold changes along with the output voltage of Output II. Use the test method below:

Add a 100k rheostat in parallel with R64 on the pin side, and adjust the rheostat to trim Output II up until the over-voltage protection functions (Output II off) .



Pin Side

3.9 Over-temperature Protection

When the thermistor temperature is at 85°C to 100°C, the over-temperature protection functions, and the output is off; when the thermistor temperature is 5 to 15°C less than the protection threshold, the module recovers automatically.

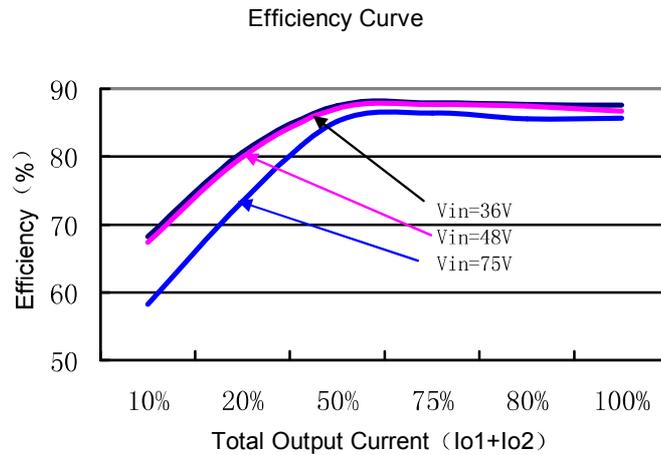
3.10 Remote on/off (Negative logic)

Output will be on when the Rem is shorted to -Vin or below 1.8V referenced to -Vin.

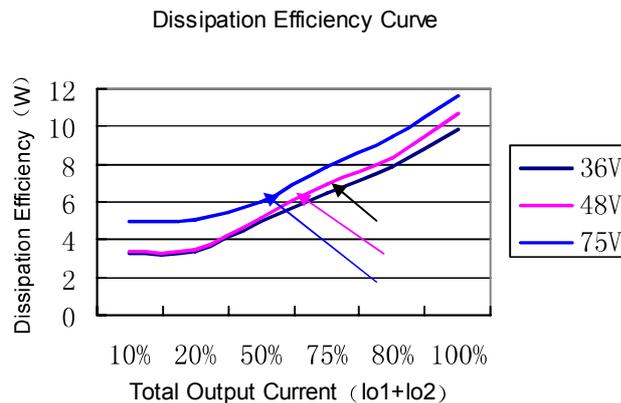
Output will be off when the Rem is higher than 1.8V referenced to -Vin or keeps open circuit.

4 Characteristic Curves (Ta=25°C)

4.1 Efficiency Curve

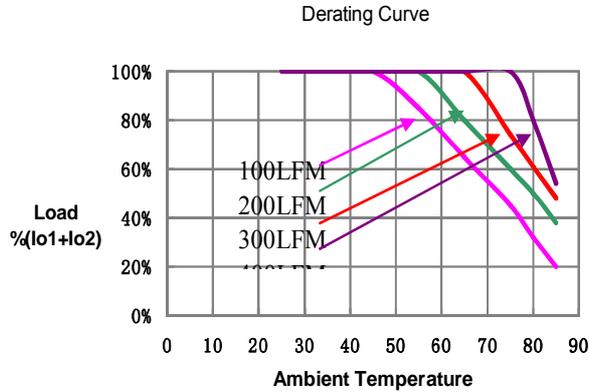


4.2 Dissipation Efficiency Curve



4.3 Thermal Derating Curve

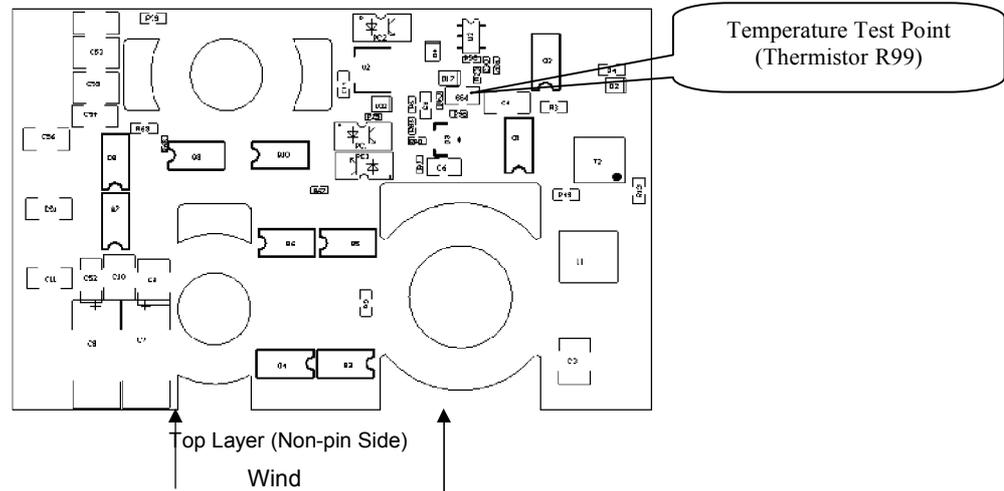
When the module operates at high temperature, the following derating curve shall be used:



Test conditions:

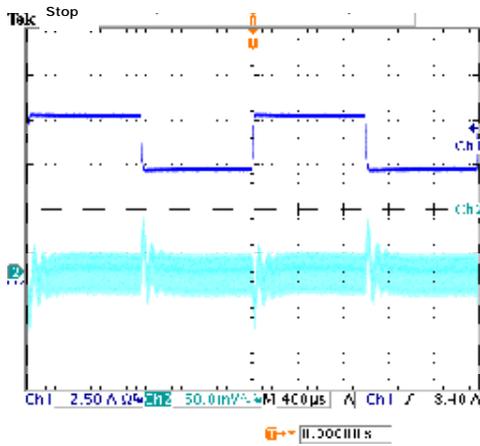
- (1) The module shall be soldered on a 2.0mm standard 4-layer test board, of which the middle two layers are two-ounce copper foils.
- (2) A certain gap is required between the module and test board. Keep the test board perpendicular to the horizontal direction and the long edge parallel with the horizontal plane.
- (3) Put the module into a thermal test box, and test the module using infrared thermal imaging equipment and thermocouple test equipment. See Next diagram.
- (4) When the module reaches thermal equilibrium state, the devices on the module can meet thermal derating requirements.

4.4 Temperature Test Point

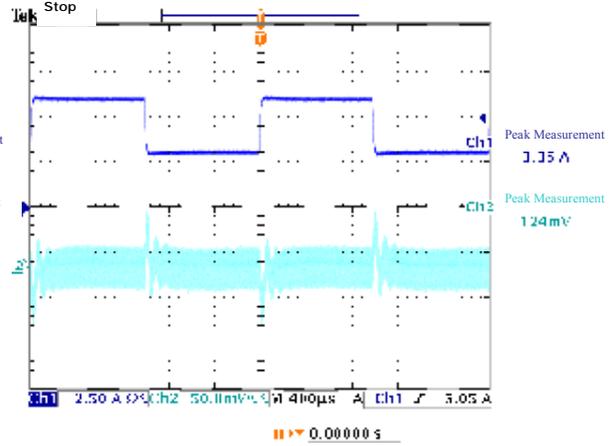


4.5 Dynamic Response

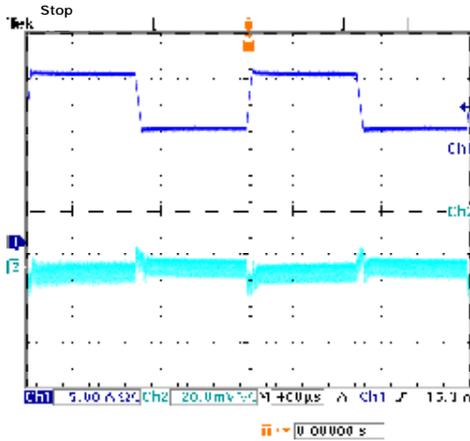
Test Condition: $T_a=25^{\circ}\text{C}$, $V_{in}=48\text{V}$, $\Delta I_o/\Delta t=1.0\text{A}/\mu\text{s}$, add a 220 μF capacitor to each output



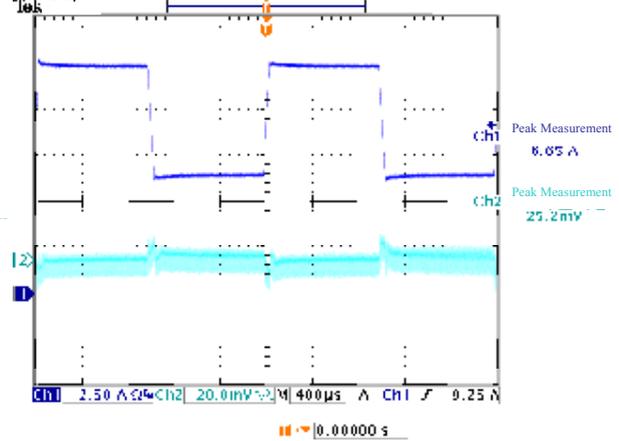
Output I (3.3V) 50%Io1~75%Io1



Output I (3.3V) 25%Io1~50%Io1



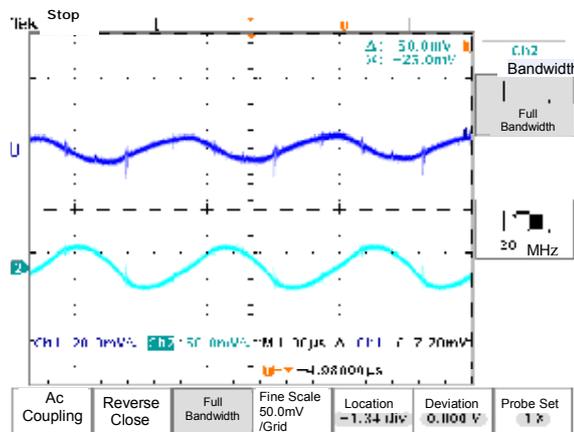
Output II (1.2V) 50%Io1~75%Io2

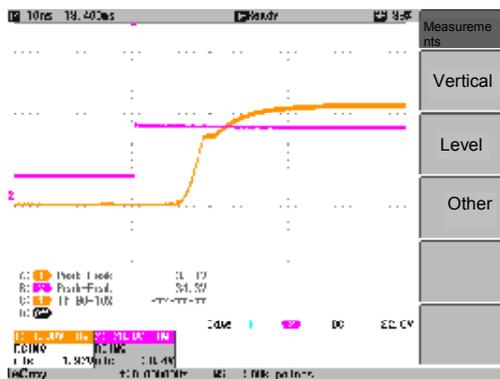


Output II (1.2V) 25%Io1~50%Io2

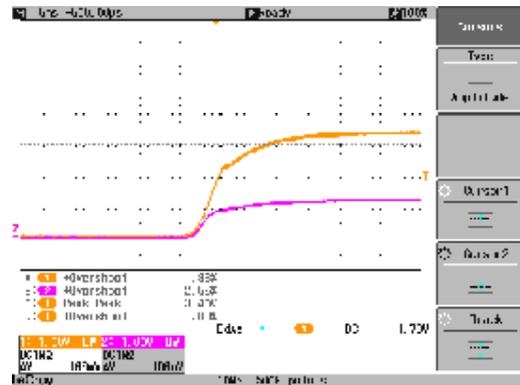
4.6 Output Ripple and Power-on Wave

Test Condition: $T_a=25^{\circ}\text{C}$, $V_{in}=48\text{V}$, $I_{o1}=12\text{A}$, $I_{o2}=25\text{A}$, 20MHz





Power-on Wave: Vin - Vo1



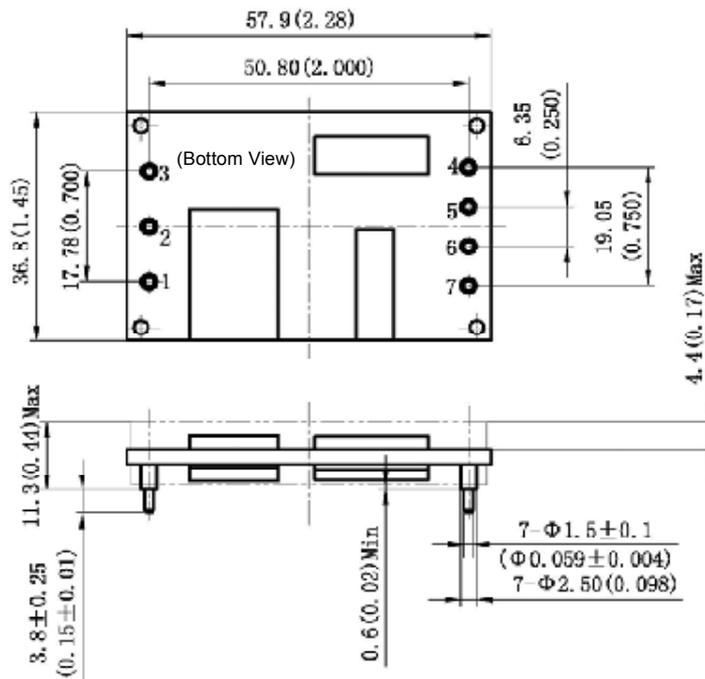
Power-on Wave: Vo1 - Vo2

5 Dimensions and Pin definition

5.1 Dimensions

The product is equipped with an option of Aluminum board, which includes through-threaded mounting holes, allowing for attachment of heat sinks. There are two outline designs: open-frame and aluminum baseplate.

1) Outline Diagram - Open-frame



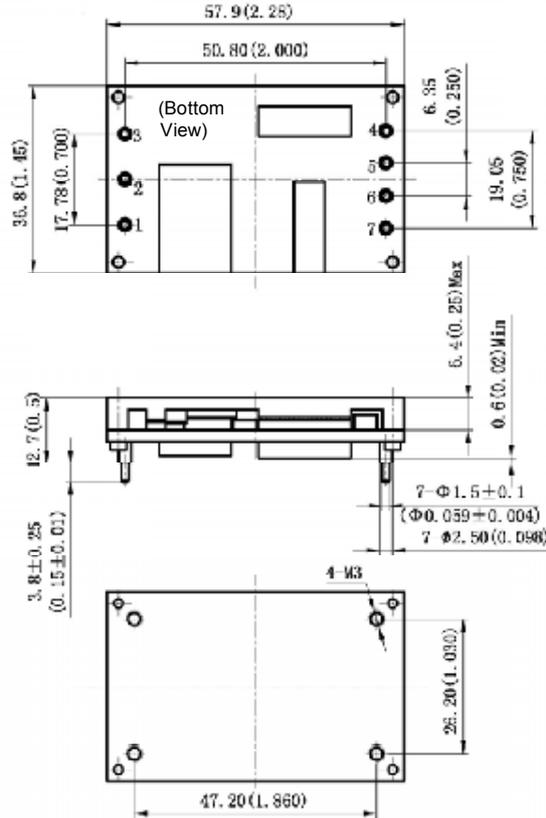
Note:

1. Unit: mm (inch)

2. Tolerance: .X±0.5(.XX±0.02); .XX±0.25(.XXX±0.010)

3. The maximum height ($\delta 1$) of the highest component at non-pin side is 4.4mm (0.17inch); the minimum space ($\delta 2$) between the highest component at pin side and the mounting surface of pin side is 0.6mm (0.02inch).

2) Outline Diagram - Aluminum Baseplate



Note:

1. Unit: mm (inch)

2. Tolerance: .X±0.5(.XX±0.02); .XX±0.25(.XXX±0.010)

3. The maximum height of the highest device at non-pin side is 6.4 (0.25); and the minimum space between the highest device at pin side and the mounting surface of pin side is 0.6 (0.02).

4. 4-M3 are the through-threaded mounting holes allowing for attachment of heat sinks. The length of M3 screw screwed into the aluminum baseplate shall be less than 3mm.

5.2 Pin Definition

No	1	2	3	4	5	6	7
Symbol	+Vin	Rem	-Vin	+Vo2	COM	Trim	+Vo1
Definition	Positive Input	Remote	Negative Input	Positive Output II	Common Terminal (Output grounding)	Trim (Output II)	Positive Output I